

### **MOSFET**

### OptiMOS™ 5 Power-Transistor, 30 V

### **Features**

- N-channel, logic level
- Very low on-resistance R<sub>DS(on)</sub>
- Superior thermal resistance
- Optimized design for double side cooling
- 100% avalanche tested
- Pb-free lead plating; RoHS compliant
- Halogen-free according to IEC61249-2-21

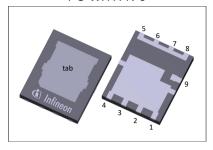
### **Product validation**

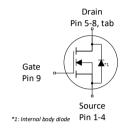
Fully qualified according to JEDEC for Industrial Applications

Table 1 Key performance parameters

| , and a manufacture parameter parame |       |      |  |  |  |  |  |  |
|--|-------|------|--|--|--|--|--|--|
| Parameter  | Value | Unit |  |  |  |  |  |  |
| $V_{ m DS}$  | 30    | V    |  |  |  |  |  |  |
| R <sub>DS(on),max</sub>  | 0.35  | mΩ   |  |  |  |  |  |  |
| $I_{D}$  | 700   | A    |  |  |  |  |  |  |
| $Q_{\rm oss}$  | 95    | nC   |  |  |  |  |  |  |
| $Q_{G}$  | 91    | nC   |  |  |  |  |  |  |

#### PG-WHTFN-9









| Type / Ordering code | Package    | Marking | Related links |
|----------------------|------------|---------|---------------|
| IQDH35N03LM5CGSC     | PG-WHTFN-9 | LA      | -             |

### Public

# OptiMOS™ 5 Power-Transistor, 30 V IQDH35N03LM5CGSC



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# OptiMOS™ 5 Power-Transistor, 30 V IQDH35N03LM5CGSC



# 1 Maximum ratings

at  $T_A$ =25 °C, unless otherwise specified

Table 2 Maximum ratings

| Parameter                                    | Symbol                  | Values |                |                         | Unit | Nicko / Took com dikion  |  |
|--|-------------------------|--------|----------------|-------------------------|------|--|--|
| raiametei                                    | Syllibol                | Min.   | Min. Typ. Max. |                         |      | Note / Test condition  |  |
| Continuous drain current <sup>1)</sup>       | I <sub>D</sub>          | -      | -              | 700<br>443<br>414<br>66 | А    | $V_{\rm GS}$ =10 V, $T_{\rm C}$ =25 °C<br>$V_{\rm GS}$ =10 V, $T_{\rm C}$ =100 °C<br>$V_{\rm GS}$ =4.5 V, $T_{\rm C}$ =100 °C<br>$V_{\rm GS}$ =10 V, $T_{\rm A}$ =25 °C, $R_{\rm thJA}$ =50 °C/W <sup>2)</sup> |  |
| Pulsed drain current <sup>3)</sup>           | I <sub>D,pulse</sub>    | -      | -              | 2800                    | А    | T <sub>C</sub> =25 °C  |  |
| Avalanche energy, single pulse <sup>4)</sup> | E <sub>AS</sub>         | -      | -              | 1200                    | mJ   | $I_{\rm D}$ =50 A, $R_{\rm GS}$ =25 Ω  |  |
| Gate source voltage                          | $V_{GS}$                | -20    | -              | 20                      | V    | -  |  |
| Power dissipation                            | P <sub>tot</sub>        | -      | -              | 278<br>2.5              | W    | $T_{\rm C}$ =25 °C<br>$T_{\rm A}$ =25 °C, $R_{\rm thJA}$ =50 °C/W <sup>2)</sup>  |  |
| Operating and storage temperature            | $T_{\rm j},T_{\rm stg}$ | -55    | -              | 150                     | °C   | -  |  |

<sup>1)</sup> Rating refers to the product only with datasheet specified absolute maximum values, maintaining case temperature as specified. For other case temperatures please refer to Diagram 2. De-rating will be required based on the actual environmental conditions.

### 2 Thermal characteristics

Table 3 Thermal characteristics

| Parameter  | Symbol     | Values |      |      | Unit  | Note / Test condition |
|--|------------|--------|------|------|-------|-----------------------|
| raiametei  | Syllibot   | Min.   | Тур. | Мах. | Ollic | note / Test condition |
| Thermal resistance, junction - case, bottom  | $R_{thJC}$ | -      | -    | 0.45 | °C/W  |                       |
| Thermal resistance, junction - case, top   | $R_{thJC}$ | -      | -    | 0.56 | °C/W  | -                     |
| Thermal resistance, junction - ambient, 6 cm <sup>2</sup> cooling area <sup>5)</sup> | $R_{thJA}$ | -      | -    | 50   | °C/W  |                       |

Device on 40 mm x 40 mm x 1.5 mm epoxy PCB FR4 with 6 cm $^2$  (one layer, 70  $\mu$ m thick) copper area for source connection. PCB is vertical in still air.

Device on 40 mm x 40 mm x 1.5 mm epoxy PCB FR4 with 6 cm $^2$  (one layer, 70  $\mu$ m thick) copper area for source connection. PCB is vertical in still air.

<sup>3)</sup> See Diagram 3 for more detailed information

<sup>4)</sup> See Diagram 13 for more detailed information

# OptiMOS™ 5 Power-Transistor, 30 V IQDH35N03LM5CGSC



### 3 Electrical characteristics

at  $T_{\rm j}$ =25 °C, unless otherwise specified

Table 4 Static characteristics

| Parameter                        | Symbol                |      | Values       |          |      | Note / Test condition   |  |
|----------------------------------|-----------------------|------|--------------|----------|------|---|--|
| raiailletei                      | Syllibot              | Min. | Тур.         | Мах.     | Unit | Note / Test condition   |  |
| Drain-source breakdown voltage   | $V_{(BR)DSS}$         | 30   | -            | -        | V    | V <sub>GS</sub> =0 V, I <sub>D</sub> =1 mA  |  |
| Gate threshold voltage           | $V_{\rm GS(th)}$      | 1.2  | 1.6          | 2.0      | V    | $V_{\rm DS} = V_{\rm GS}, I_{\rm D} = 1460  \mu \text{A}$                                   |  |
| Zero gate voltage drain current  | I <sub>DSS</sub>      | -    | 0.1<br>10    | 1<br>100 | μΑ   | $V_{DS}$ =24 V, $V_{GS}$ =0 V, $T_j$ =25 °C<br>$V_{DS}$ =24 V, $V_{GS}$ =0 V, $T_j$ =125 °C |  |
| Gate-source leakage current      | I <sub>GSS</sub>      | -    | 10           | 100      | nA   | V <sub>GS</sub> =20 V, V <sub>DS</sub> =0 V   |  |
| Drain-source on-state resistance | $R_{\mathrm{DS(on)}}$ | -    | 0.31<br>0.36 |          | mΩ   | $V_{\rm GS}$ =10 V, $I_{\rm D}$ =50 A<br>$V_{\rm GS}$ =4.5 V, $I_{\rm D}$ =50 A             |  |
| Gate resistance                  | $R_{G}$               | -    | 0.47         | -        | Ω    | -   |  |
| Transconductance                 | $g_{fs}$              | 265  | 530          | -        | S    | $ V_{\rm DS}  \ge 2 I_{\rm D} R_{\rm DS(on)max}$ , $I_{\rm D}=50$ A                         |  |

Table 5 Dynamic characteristics

| Parameter                                  | Symbol           | Values |       |     | ╛,       | Jnit  | Note / Test condition  |  |
|--|------------------|--------|-------|-----|----------|-------|--|--|
|  | Syllibot         | Min.   | Тур.  | Max | $\cdot $ | Jilit | Note / Test condition  |  |
| Input capacitance <sup>6)</sup>            | C <sub>iss</sub> | -      | 14000 | 18  | 000      | pF    |  |  |
| Output capacitance <sup>6)</sup>           | Coss             | _      | 3300  | 43  | 00       | pF    | $V_{\rm GS}$ =0 V, $V_{\rm DS}$ =15 V, $f$ =1 MHz              |  |
| Reverse transfer capacitance <sup>6)</sup> | C <sub>rss</sub> | -      | 270   | 47  | )        | pF    |  |  |
| Turn-on delay time                         | $t_{\sf d(on)}$  | -      | 12    | ı   | ns       |       |  |  |
| Rise time                                  | $t_{\rm r}$      | -      | 5     | ı   | ns       |       | $V_{DD}$ =15 V, $V_{GS}$ =10 V, $I_{D}$ =50 A, $R_{G,ext}$ =1. |  |
| Turn-off delay time                        | $t_{\sf d(off)}$ | -      | 70    | -   | ns       |       | 6 Ω  |  |
| Fall time                                  | $t_{f}$          | _      | 14    | -   | ns       |       |  |  |

<sup>6)</sup> Defined by design. Not subject to production test.

## OptiMOS™ 5 Power-Transistor, 30 V IQDH35N03LM5CGSC



Table 6 Gate charge characteristics 7)

| Parameter                          | Symbol            | Values |      |      | Unit | Note / Test condition   |  |
|------------------------------------|-------------------|--------|------|------|------|---|--|
| raiailletei                        | Syllibot          | Min.   | Тур. | Мах. |      | Note / Test condition   |  |
| Gate to source charge              | $Q_{\mathrm{gs}}$ | -      | 31   | -    | nC   |   |  |
| Gate charge at threshold           | $Q_{g(th)}$       | -      | 22   | -    | nC   |   |  |
| Gate to drain charge <sup>8)</sup> | $Q_{gd}$          | -      | 18   | 27   | nC   |   |  |
| Switching charge                   | $Q_{sw}$          | -      | 27   | -    | nC   | $V_{\rm DD}$ =15 V, $I_{\rm D}$ =50 A, $V_{\rm GS}$ =0 to 4.5 V |  |
| Gate charge total <sup>8)</sup>    | $Q_{ m g}$        | -      | 91   | 114  | nC   |   |  |
| Gate plateau voltage               | $V_{ m plateau}$  | -      | 2.3  | -    | ٧    |   |  |
| Gate charge total <sup>8)</sup>    | $Q_{\mathrm{g}}$  | -      | 197  | 262  | nC   | $V_{\rm DD}$ =15 V, $I_{\rm D}$ =50 A, $V_{\rm GS}$ =0 to 10 V  |  |
| Gate charge total, sync. FET       | $Q_{g(sync)}$     | -      | 86   | -    | nC   | V <sub>DS</sub> =0.1 V, V <sub>GS</sub> =0 to 4.5 V             |  |
| Output charge <sup>8)</sup>        | Q <sub>oss</sub>  | -      | 95   | 126  | nC   | V <sub>DS</sub> =15 V, V <sub>GS</sub> =0 V                     |  |

<sup>7)</sup> See "Gate charge waveforms" for parameter definition

### Table 7 Reverse diode

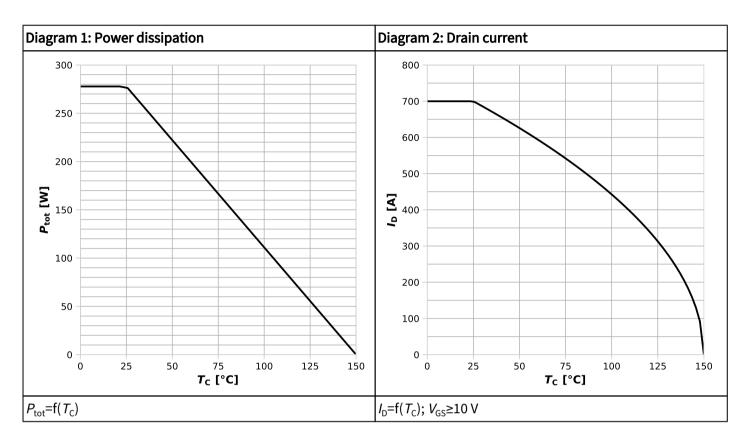
| Parameter                             | Symbol               | Values |      |      | Unit  | Note / Test condition  |  |
|---------------------------------------|----------------------|--------|------|------|-------|--|--|
| raiametei                             | Symbol               | Min.   | Тур. | Мах. | Oilit | Note / Test condition  |  |
| Diode continuous forward current      | $I_{S}$              | -      | -    | 236  | А     | - <i>T<sub>c</sub></i> =25 °C  |  |
| Diode pulse current                   | I <sub>S,pulse</sub> | -      | -    | 2800 | А     | 7 <sub>C</sub> -23 C   |  |
| Diode forward voltage                 | $V_{\rm SD}$         | -      | 0.72 | 1.0  | V     | $V_{\rm GS}$ =0 V, $I_{\rm F}$ =50 A, $T_{\rm j}$ =25 °C                   |  |
| Reverse recovery time <sup>9)</sup>   | $t_{rr}$             | -      | 49   | 98   | ns    | V-15 V I-25 A di/d+100 A/uc  |  |
| Reverse recovery charge <sup>9)</sup> | $Q_{\rm rr}$         | -      | 64   | 128  | nC    | $V_{\rm R}$ =15 V, $I_{\rm F}$ =25 A, d $i_{\rm F}$ /d $t$ =100 A/ $\mu$ s |  |
| Reverse recovery time <sup>9)</sup>   | t <sub>rr</sub>      | -      | 33   | 66   | ns    | V-15 V I-50 A di /d+500 A/us   |  |
| Reverse recovery charge <sup>9)</sup> | $Q_{\rm rr}$         | -      | 152  | 304  | nC    | $V_{\rm R}$ =15 V, $I_{\rm F}$ =50 A, d $I_{\rm F}$ /d $t$ =500 A/ $\mu$ s |  |

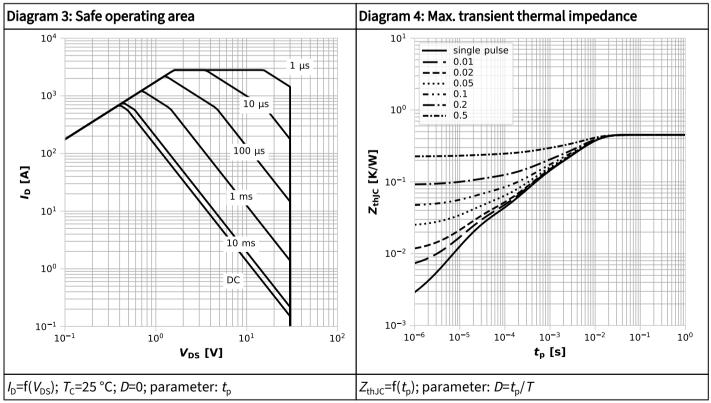
<sup>&</sup>lt;sup>9)</sup> Defined by design. Not subject to production test.

<sup>8)</sup> Defined by design. Not subject to production test.

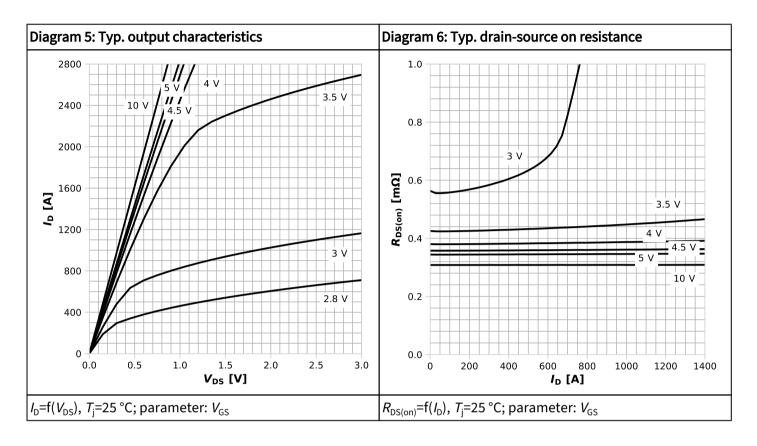


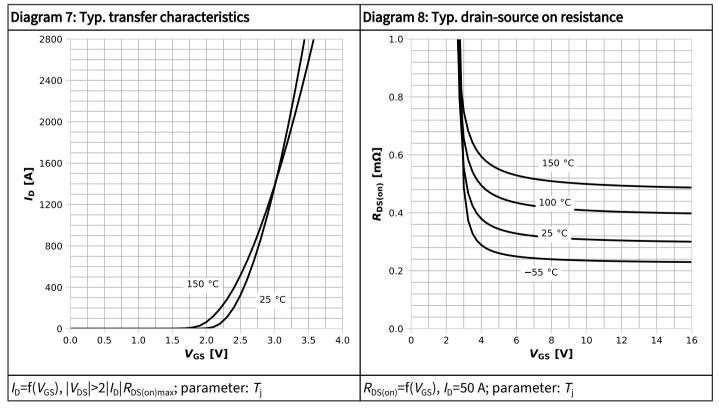
# 4 Electrical characteristics diagrams



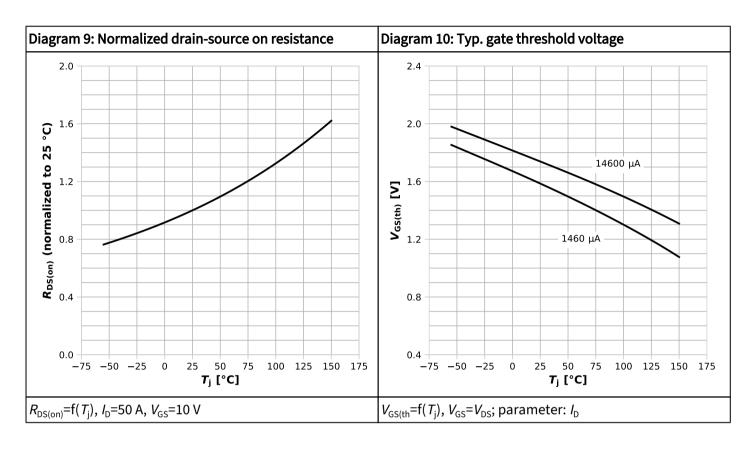


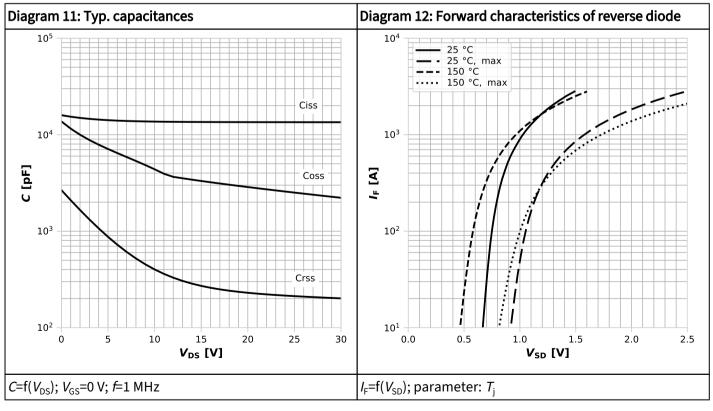




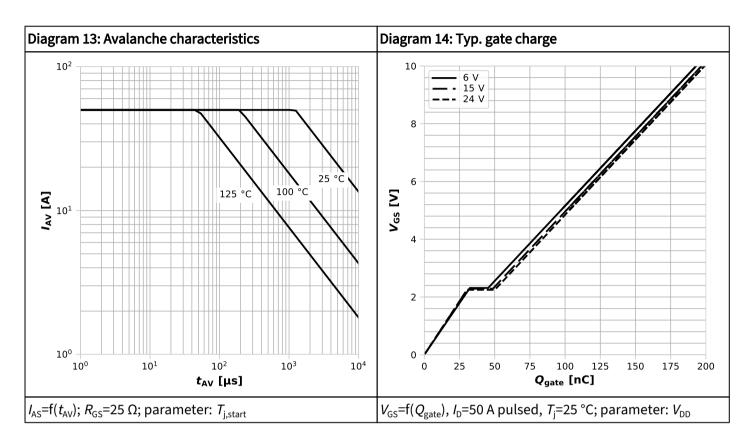


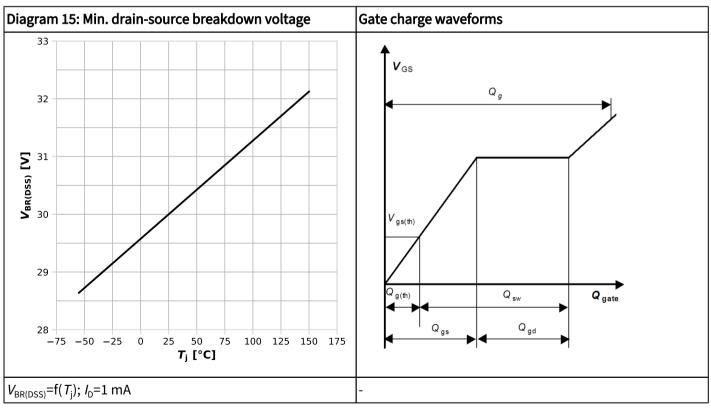






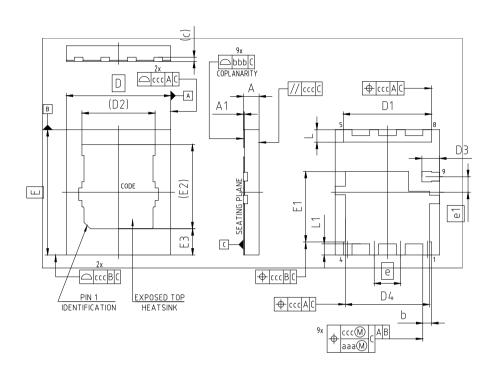








# 5 Package outlines



| PACKAGE - GROUP<br>NUMBER: | PG-WHT | FN-9-U02   |            |        |      |
|----------------------------|--------|------------|------------|--------|------|
| DIMENSIONS MILLIMETERS     |        | DIMENSIONS | MILLI      | METERS |      |
| DIMENSIONS                 | MIN.   | MAX.       | DIMENSIONS | MIN.   | MAX. |
| Α                          | 0.55   | 0.75       | е          | 1      | .27  |
| A1                         | 0.00   | 0.05       | e1         | 0      | .75  |
| b                          | 0.32   | 0.52       | L          | 0.50   | 0.70 |
| С                          | 0.     | 20         | L1         | 0.44   | 0.64 |
| D                          | 5.00   |            | aaa        | 0.05   |      |
| D1                         | 4.13   | 4.33       | bbb        | 0.08   |      |
| D2                         | 3.     | 50         | ccc        | 0.10   |      |
| D3                         | 0.75   | 0.95       |            |        |      |
| D4                         | 3.93   | 4.13       |            |        |      |
| E                          | 6.     | 00         |            |        |      |
| E1                         | 3.28   | 3.48       |            |        |      |
| E2                         | 4.     | 03         |            |        |      |
| E3                         | 1.16   | 1.36       |            |        |      |

NOTE: DIMENSIONS DO NOT INCLUDE MOLD FLASH, PROTRUSION OR GATE BURRS

Figure 1 Outline PG-WHTFN-9, dimensions in mm



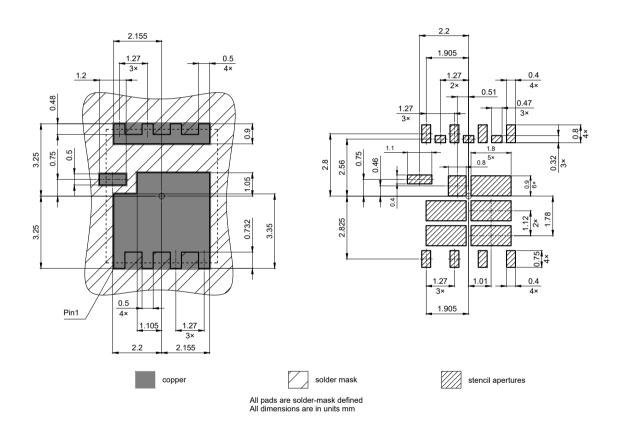


Figure 2 Footprint drawing PG-WHTFN-9, dimensions in mm

## OptiMOS™ 5 Power-Transistor, 30 V IQDH35N03LM5CGSC



### **Revision history**

IODH35N03LM5CGSC

### Revision 2024-10-16, Rev. 2.1

#### Previous revisions

| Revision | Date       | Subjects (major changes since last revision) |
|----------|------------|--|
| 2.0      | 2024-06-14 | Release of final                             |
| 2.1      | 2024-10-16 | Update package drawing and diagram circuit   |

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